

MECHANICAL CASE OUTLINE

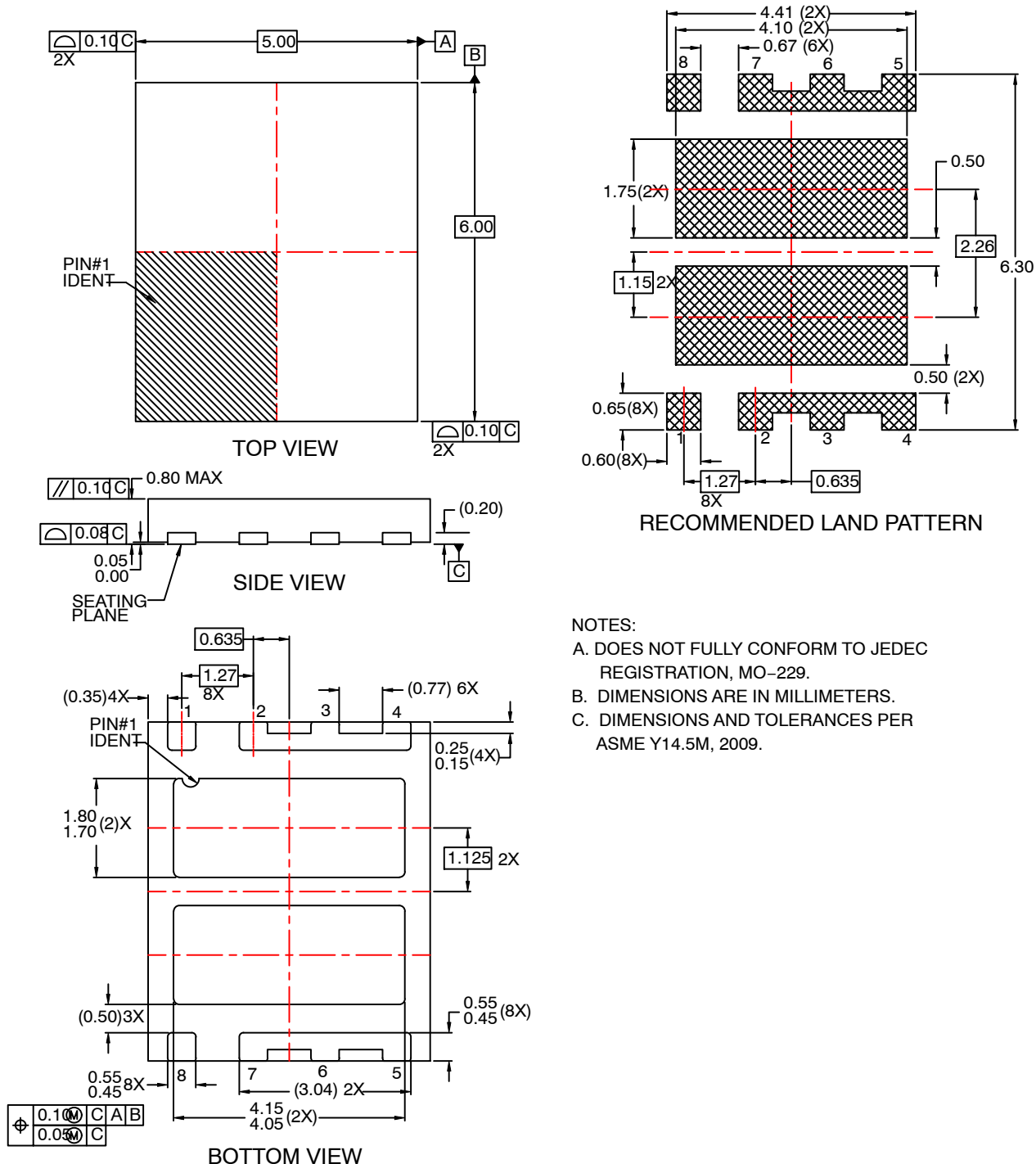
PACKAGE DIMENSIONS

ON Semiconductor®



WDFN8 5x6, 1.27P
CASE 511DC
ISSUE O

DATE 31 AUG 2016



- NOTES:
- A. DOES NOT FULLY CONFORM TO JEDEC REGISTRATION, MO-229.
 - B. DIMENSIONS ARE IN MILLIMETERS.
 - C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.

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